

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of:

Thomas Teuschler et al.

Group Art Unit: 2813

Examiner: Tuan H. Nguyen

Serial No.: 10/762,111

Filed: January 21, 2004

For: POLISHED SEMICONDUCTOR WAFER  
AND PROCESS FOR PRODUCING IT

Attorney Docket No.: WSAG 0144 PUS

**AMENDMENT UNDER 37 C.F.R. § 1.111**

Mail Stop Amendment  
Commissioner for Patents  
U.S. Patent and Trademark Office  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Responsive to the Office Action dated April 14, 2006, please amend the above-identified application as follows:

**CERTIFICATE OF ELECTRONIC FILING**

**This paper, including all enclosures referred to herein, is being electronically filed with the U.S. Patent and Trademark Office EFS-Web System on: July 14, 2006.**